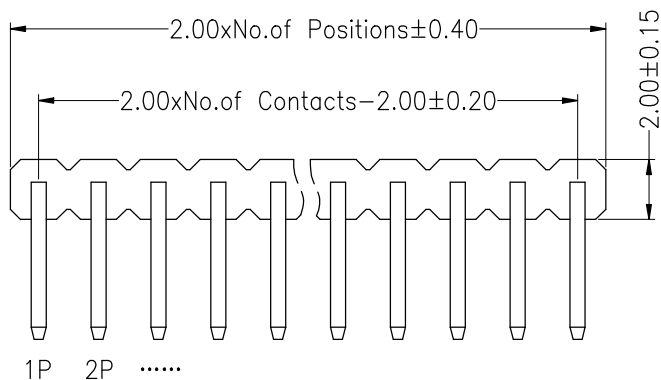




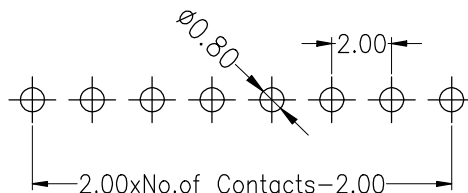
SPECIFICATIONS

Rated Current:2.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC
Insulation Resistance:1000MΩ Min
Operation Temperature:-40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V-0)
Standard: PA6T
Soldering temperature:260℃±5° 5S



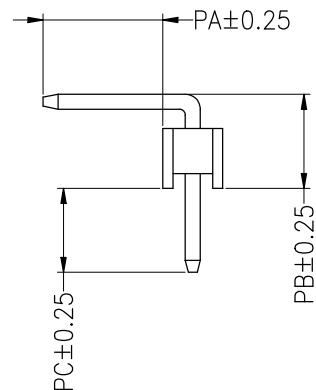
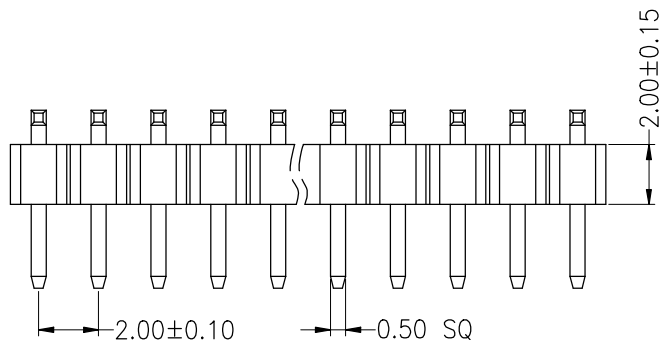
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



Ordering Information

1320 11 XX X N XX R XXX X XX

No.of Pins 01~40P	Insulator Material Option	Contact Plating	Pin Length	Packing	code stream
	A=BK-PBT	G0:Gold Flash		0=PE Bag	01~99
	C=BK-PA6T	G1:1u" Gold		A=Tray	
	E=BK-PA9T	G2:1.5u" Gold			
	F=BK-LCP	G3:2u" Gold			
		G4:3u" Gold			
		G5:5u" Gold			
		G6:10u" Gold			
		G7:15u" Gold			
		G8:30u" Gold			
		S0:Gold Flash/Tin			
		SN:Tin			



Dimension antitheses list

ITEM	PA	PB	PC
Standard	4.00	3.15	2.80

OPERATION

X.X

±0.30

X.XX

±0.20

X.XXX

±0.10

Angle

±3°

DIM

TOL

DRAW

YiYuSheng

12.04.18

SCALE

FIT

UNIT

mm

SIZE

A4

SHEET

1/1

PROJ.

☞

JILN®深圳锦凌电子股份有限公司
SHENZHEN JINLING ELECTRONICS CO.,LTD

Tel: 86-755-27483253 Fax: 86-755-2997-5588

PART NO.

132011XXXNXXRXXXXXX

TITLE:

2.0PH H2.0mm 1xNpin 90°

1320	11 XX	X	N	XX	R	XXX	X	XX
No.of Pins 01~40P	Insulator Material Option	Contact Plating	Pin Length	Packing	code stream			
	A=BK-PBT	G0:Gold Flash		0=PE Bag	01~99			
	C=BK-PA6T	G1:1u" Gold		A=Tray				
	E=BK-PA9T	G2:1.5u" Gold						
	F=BK-LCP	G3:2u" Gold						
		G4:3u" Gold						
		G5:5u" Gold						
		G6:10u" Gold						
		G7:15u" Gold						
		G8:30u" Gold						
		S0:Gold Flash/Tin						
		SN:Tin						

A0 2012.04.18 NEW DRAWING

REV DATE MODIFICATION DESCRIPTION

CHANGE